

04-20-2005

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To the Director of the United States

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and the attached original documents or copy thereof.

1. Name of conveying party(ies):

MURAKAMI, Yoshio

YAMAZAKI, Toru

AOKI, Yoshiro

ENDO, Akihiko

2. Name and address of receiving party(ies):

Name: Sumitomo Mitsubishi Silicon CorporationAddress: 2-1 Shibaura 1-chomeMinato-kuCity: Tokyo

State/Prov.: _____

Country: JapanZIP: 105-8634

Additional name(s) & address(es)

☐ Yes ☒ No

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other _____Execution Date: 3/31/05, 4/4/05, 3/31/05 & 3/31/05

Additional name(s) & address(es)

☐ Yes ☒ No

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is: 3/31, 4/4, 3/31, 3/31/05

Patent Application No.

Filing date

B. Patent No.(s)

04/12/2005 RMEBRAHT 00000043 11101870

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Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Jeff RothenbergRegistration No. 26,429Address: Heslin Rothenberg Farley & Mesiti P.C.5 Columbia CircleCity: AlbanyState/Prov.: NYCountry: U.S.ZIP: 122036. Total number of applications and patents involved: 17. Total fee (37 CFR 3.41):.....\$ 40.00☒ Enclosed - Any excess or insufficiency should be credited or debited to deposit account☐ Authorized to be charged to deposit account

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9. Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*Jeff Rothenberg

Name of Person Signing

Signature

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Date

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ASSIGNMENT

(譲渡証)

IN CONSIDERATION of the sum of One Dollar (\$1 .00) or the equivalent thereof, and other good and valuable consideration paid to Yoshio Murakami, Toru Yamazaki, Yoshiro Aoki, and Akihiko Endo, citizens of Japan by Sumitomo Mitsubishi Silicon Corporation corporations organized under the laws of Japan, located at 2-1 Shibaura 1-chome, Minato-ku, Tokyo 105-8634 Japan, respectively, receipt of which is hereby acknowledged, we, the said Yoshio Murakami, Toru Yamazaki, Yoshiro Aoki, and Akihiko Endo, do hereby sell and assign to said Sumitomo Mitsubishi Silicon Corporation, their successors and assigns, all our right, title and interest, in and for the United States of America, in and to

METHOD FOR MANUFACTURING SILICON-ON-INSULATOR WAFER

invented by us and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Sumitomo Mitsubishi Silicon Corporation, their successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by us if this assignment and sale had not been made;

And we hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And we do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Sumitomo Mitsubishi Silicon Corporation

Signed on the date(s) indicated aside signatures:

INVENTOR(S) (発明者フルネームサイン)	Date signed (署名日)
1) <u>Yoshio Murakami</u> Yoshio Murakami	<u>March 31, 2005</u>
2) <u>Toru Yamazaki</u> Toru Yamazaki	<u>April 4, 2005</u>
3) <u>Yoshiro Aoki</u> Yoshiro Aoki	<u>March 31, 2005</u>
4) <u>Akihiko Endo</u> Akihiko Endo	<u>March 31, 2005</u>